

SID

Factory: Rot am See

Article:

ML10

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	 B00
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	168		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		
		70	L2	
C-STD-FR4-ML-0.203mm-070+070-TG150-H...	50203119	203	4	
		70	L3	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	183	5	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0	6	
		70	L4	
C-STD-FR4-ML-0.203mm-070+070-TG150-H...	50203119	203	7	
		70	L5	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	183	8	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0	9	
		70	L6	
C-STD-FR4-ML-0.203mm-070+070-TG150-H...	50203119	203	10	
		70	L7	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	183	11	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0	12	
		70	L8	
C-STD-FR4-ML-0.203mm-070+070-TG150-H...	50203119	203	13	
		70	L9	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	168	14	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0	15	
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2327 µm

Version 1.2.20.35

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